# PCle-6738 Specifications



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# PCIe-6738 Specifications

#### **Definitions**

**Warranted** specifications describe the performance of a model under stated operating conditions and are covered by the model warranty.

**Characteristics** describe values that are relevant to the use of the model under stated operating conditions but are not covered by the model warranty.

- *Typical* specifications describe the performance met by a majority of models.
- **Nominal** specifications describe an attribute that is based on design, conformance testing, or supplemental testing.

Specifications are *Typical* unless otherwise noted.

## **Conditions**

Specifications are valid at 25 °C unless otherwise noted.

## **Analog Output**

Number of channels	32 voltage outputs
Resolution	16 bits, 1 in 65,536
DNL	±1.0 LSB maximum
Unscaled data format <sup>[1]</sup>	Unsigned integer (0 to 65,535)

Monotonicity	16 bits		
Accuracy	Refer to the <i>AO Absolute Accuracy</i> table		
Maximum update rate (using local FIF	O) <sup>[2]</sup>		
1 channel		1 MS/s	
8 channels (1 channel per bank) [3]		1 MS/s	
32 channels <sup>[3]</sup>		350 kS/s	
Timing accuracy (warranted)	50 ppm of sample rate		
Timing resolution	10 ns		
Output range	±10 V		
Output coupling	DC		
Output impedance	0.2 Ω		
Output current drive <sup>[4]</sup>	±10 mA		
Overdrive protection	±15 V		

Overdrive current	15 mA
Power-on state	±200 mV
Power-on/off glitch	3.0 V peak for 100 ms
FIFO buffer size	65,535 samples shared among channels used
Data transfers	DMA (scatter-gather), programmed I/O

#### AO waveform modes

- Nonperiodic waveform
- Periodic waveform regeneration mode from onboard FIFO
- Periodic waveform regeneration from host buffer including dynamic update

Settling time, full scale step	15 μs to ±4 LSB			
Slew rate	3.0 V/μs			
Noise	1.0 mV RMS, DC to 1 MHz			
AO update glitch				
Magnitude		3.0 mV		
Duration		10 μs		

Glitch energy		3 nVs
Channel crosstalk	-65 dB with SHC68-68-A2 cable (generating kHz on the reference channel)	a 10 V, 100 point sinusoidal at 100
Output stability	Any passive load	



**Note** AO update glitch is the glitch energy that occurs on all channels on the same bank as the result of a channel update, regardless of value. For example, if you update the value of AO 0, all channels within that bank AO <0..3> will experience this glitch regardless of whether their output voltages change.

#### **Absolute Accuracy (Warranted)**

Absolute accuracy at full-scale number is valid immediately following self calibration and assumes the device is operating within 10 °C of the last external calibration.

**Table 1.** AO Absolute Accuracy

Nominal Range Positive Full Scale	Nominal Range Negative Full Scale	Residual Gain Error (ppm of Reading)	Gain Tempco (ppm/°C)	Reference Tempco (ppm/°C)	Offset Tempco (ppm)	Residual Offset Error (ppm of Range)	INL Error (ppm of Range)	Absolute Accuracy at Full Scale (µV)	
10	-10	109	12	1	4	95	64	2,940	



**Note** Accuracies listed are valid for up to two years from the device external calibration.

**AO Absolute Accuracy Equation** 

AbsoluteAccuracy = OutputValue · (GainError) + Range · (OffsetError)

- GainError = ResidualGainError + GainTempco · (TempChangeFromLastInternalCal) + ReferenceTempco · (TempChangeFromLastExternalCal)
- OffsetError = ResidualOffsetError + OffsetTempco · (TempChangeFromLastInternalCal) + INL\_Error



Notice Electromagnetic interference can adversely affect the measurement accuracy of this product. The analog output pins of this device are not protected for lectromagnetic interference. As a result, this device may experience reduced accuracy or other temporary performance degradation when connected cables are routed in an environment with radiated or conducted radio frequency electromagnetic interference.

# Digital I/O/PFI

#### **Static Characteristics**

Number of channels	10 total, 2 (P0.<01>), 8 (PFI<07>/P1.<07>)
Ground reference	D GND
Direction control	Each terminal individually programmable as input or output
Pull-down resistor	50 kΩ typical, 20 kΩ minimum
Input voltage protection <sup>[5]</sup>	±20 V on up to two pins

# Waveform Characteristics (Port 0 Only)

Terminals used		Port 0 (P0.<0.1>)	
Port/sample size		Up to 2 bits	
Waveform generation (DO) FIFO		2,047 samples	
Waveform acquisition (DI) FIFO		255 samples	
DI Sample Clock Frequency		0 to 10 MHz, system and bus activity dependent	
DO Sample Clock frequency			
Regenerate from FIFO	0 to 1	10 MHz	
Streaming from memory	0 to 10 MHz, system and bus activity dependent		
Data transfers		DMA (scatter-gather), programmed I/O	
Digital line filter settings		160 ns, 10.24 μs, 5.12 ms, disable	

# PFI/Port 1 Functionality

Functionality	Static digital input, static digital output, timing input, timing output
Timing output	Many AI, AO, counter, DI, DO timing signals

sources	
Debounce filter settings	90 ns, 5.12 μs, 2.56 ms, custom interval, disable; programmable high and low transitions; selectable per input

# **Recommended Operating Conditions**

Input high voltage (V <sub>IH</sub> )	2.2 V mir	nimum, 5.25 V maximum	
Input low voltage (V <sub>IL</sub> )	0 V minimum, 0.8 V maximum		
Output high current (I <sub>OH</sub> )			
P0.<01>		-24 mA maximum	
PFI <07>/PI<07>		-16 mA maximum	
Output low current (I <sub>OL</sub> )			
P0.<01>		24 mA maximum	
PFI <07>/P1<07>		16 mA maximum	

## **Electrical Characteristics**

Level	Minimum	Maximum
Positive-going threshold (VT+)	_	2.2 V

Level	Minimum	Maximum
Negative-going threshold (VT-)	0.8 V	_
Delta VT hysteresis (VT+ - VT-)	0.2 V	_
I <sub>IL</sub> input low current (V <sub>in</sub> = 0 V)	_	-10 μΑ
I <sub>IH</sub> input high current (V <sub>in</sub> = 5 V)	_	250 μΑ

# Digital I/O Characteristics

Figure 1. P0.<0..1>: I<sub>OH</sub> versus V<sub>OH</sub>

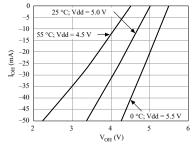


Figure 2. PFI <0..7>/PI: I<sub>OH</sub> versus V<sub>OH</sub>

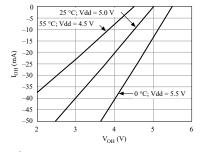


Figure 3. P0.<0..1>: I<sub>OL</sub> versus V<sub>OL</sub>

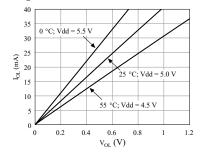
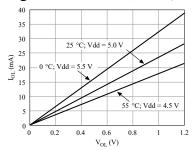


Figure 4. PFI <0..7>/P1: I<sub>OL</sub> versus V<sub>OL</sub>



# Timing I/O

Number of counter/timers	4
Resolution	32 bits
Counter measurements	Edge counting, pulse, pulse width, semi-period, period, two-edge separation
Position measurements	X1, X2, X4 quadrature encoding with Channel Z reloading; two-pulse encoding
Output applications	Pulse, pulse train with dynamic updates, frequency division, equivalent time sampling
Internal base clocks	100 MHz, 20 MHz, 100 kHz
External base clock frequency	0 MHz to 25 MHz
Base clock accuracy (warranted)	50 ppm

Inputs	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down, Sample Clock
Routing options for inputs	Any PFI, RTSI, analog trigger, many internal signals
FIFO	127 samples per counter
Data transfers	Dedicated scatter-gather DMA controller for each counter/timer, programmed I/O

# Phase-Locked Loop (PLL)

#### Table 2. Reference Clock Locking Frequencies

Reference Signal	Locking Input Frequency (MHz)
RTSI <07>	10,20
PFI <07>	10, 20

Outside of PLL	100 MHz Timebase; other signals derived from 100 MHz Timebase including 20 MHz and 100 kHz Timebases

# **External Digital Triggers**

Source	Any PFI, RTSI

Polarity	Software-selectable for most signals
Analog output function	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase
Counter/timer functions	Gate, Source, HW_Arm, Aux, A, B, Z, Up_Down, Sample Clock
Digital waveform generation (DO) function	Start Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase
Digital waveform acquisition (DI) function	Start Trigger, Reference Trigger, Pause Trigger, Sample Clock, Sample Clock Timebase

# **Device-to-Device Trigger Bus**

Input source	RTSI <07>
Output destination	RTSI <07>
Output selections	10 MHz Clock; many internal signals
Debounce filter settings	90 ns, 5.12 μs, 2.56 ms, custom interval, disable; programmable high and low transitions; selectable per input

#### **Bus Interface**

Form factor	x4 PCI Express, specification v1.1 compliant
Slot compatibility	x4, x8, and x16 PCI Express slots <sup>[6]</sup>
DMA channels	7 DMA, analog output, digital input, digital output, counter/timer 0, counter/timer 1, counter/timer 2, counter/timer 3

# **Power Requirements**



**Notice** The protection provided by the PCIe-6738 can be impaired if it is used in a manner not described in the user documentation.

+3.3 V	3.0 W
+12 V	14.0 W

# **Current Limits**



**Caution** Exceeding the current limits may cause unpredictable behavior by the device and/or chassis.

+5 V terminal (connector 0)	1 A maximum <sup>[7]</sup>
P0/P1/PFI terminals combined	1.4 A maximum

# **Physical**

Printed circuit board dimensions	16.8 cm × 11.1 cm (6.60 in. × 4.38 in.)
Weight	110 g (3.8 oz)
I/O connector	1 68-pin VHDCI
Form factor	Standard height, half length, single slot
Integrated air mover (fan)	No

## **Calibration**

Recommended warm-up time	15 minutes
Calibration interval	2 years

## **Safety Voltages**

Connect only voltages that are below these limits.

Channel-to-earth ground	±11 V, Measurement Category I
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Measurement Category I is for measurements performed on circuits not directly connected to the electrical distribution system referred to as MAINS voltage. MAINS is a hazardous live electrical supply system that powers equipment. This category is for

measurements of voltages from specially protected secondary circuits. Such voltage measurements include signal levels, special equipment, limited-energy parts of equipment, circuits powered by regulated low-voltage sources, and electronics.



**Caution** Do not connect the PCIe-6738 to signals or use for measurements within Measurement Categories II, III, or IV.



**Note** Measurement Categories CAT I and CAT O are equivalent. These test and measurement circuits are for other circuits not intended for direct connection to the MAINS building installations of Measurement Categories CAT II, CAT III, or CAT IV.

#### **Environmental**

Maximum altitude	2,000 m (800 mbar) (at 25 °C ambient temperature)
Pollution degree	2

Indoor use only.



**Note** Clean the device with a soft, non-metallic brush. Make sure that the device is completely dry and free from contaminants before returning it to service.

This product meets the requirements of the following environmental standards for electrical equipment for measurement, control, and laboratory use.

#### **Operating Environment**

Operating temperature, local <sup>[8]</sup>	0 °C to 55 °C

	(IEC 60068-2-1 and IEC 60068-2-2)
Operating humidity	10% to 90% RH, noncondensing (IEC 60068-2-78)
System slot airflow	0.4 m/s (80 LFM)

## **Storage Environment**

Ambient temperature range	-20 °C to 70 °C (IEC 60068-2-1 and IEC 60068-2-2)
Relative humidity range	5% to 95% RH, noncondensing (IEC 60068-2-78)

## **Safety Compliance Standards**

This product is designed to meet the requirements of the following electrical equipment safety standards for measurement, control, and laboratory use:

- IEC 61010-1, EN 61010-1
- UL 61010-1, CSA C22.2 No. 61010-1



**Note** For safety certifications, refer to the product label or the <u>Product</u> Certifications and Declarations section.

## **Electromagnetic Compatibility Standards**

This product meets the requirements of the following EMC standards for electrical equipment for measurement, control, and laboratory use:

- EN 61326-1 (IEC 61326-1): Class A emissions; Basic immunity
- EN 55011 (CISPR 11): Group 1, Class A emissions
- AS/NZS CISPR 11: Group 1, Class A emissions
- FCC 47 CFR Part 15B: Class A emissions
- ICES-001: Class A emissions



**Note** Group 1 equipment (per CISPR 11) is any industrial, scientific, or medical equipment that does not intentionally generate radio frequency energy for the treatment of material or inspection/analysis purposes.



**Note** In the United States (per FCC 47 CFR), Class A equipment is intended for use in commercial, light-industrial, and heavy-industrial locations. In Europe, Canada, Australia and New Zealand (per CISPR 11) Class A equipment is intended for use only in heavy-industrial locations.

# CE Compliance ( E

This product meets the essential requirements of applicable European Directives, as follows:

- 2014/35/EU; Low-Voltage Directive (safety)
- 2014/30/EU; Electromagnetic Compatibility Directive (EMC)
- 2011/65/EU; Restriction of Hazardous Substances (RoHS)

#### **Product Certifications and Declarations**

Refer to the product Declaration of Conformity (DoC) for additional regulatory compliance information. To obtain product certifications and the DoC for NI products, visit <u>ni.com/product-certifications</u>, search by model number, and click the appropriate link.

## **Environmental Management**

NI is committed to designing and manufacturing products in an environmentally responsible manner. NI recognizes that eliminating certain hazardous substances from our products is beneficial to the environment and to NI customers.

For additional environmental information, refer to the **Engineering a Healthy Planet** web page at <u>ni.com/environment</u>. This page contains the environmental regulations and directives with which NI complies, as well as other environmental information not included in this document.

#### **EU and UK Customers**

• 🕱 Waste Electrical and Electronic Equipment (WEEE)—At the end of the product life cycle, all NI products must be disposed of according to local laws and regulations. For more information about how to recycle NI products in your region, visit ni.com/environment/weee.

#### 电子信息产品污染控制管理办法(中国RoHS)

• ❷⑤❷ 中国RoHS— NI符合中国电子信息产品中限制使用某些有害物质指令 (RoHS)。关于NI中国RoHS合规性信息,请登录 ni.com/environment/ rohs china。 (For information about China RoHS compliance, go to ni.com/ environment/rohs china.)